PM0062
Programming manual

STM32L151xx and STM32L152xx Flash and EEPROM programming

Introduction

This programming manual describes how to program the Flash memory of the STM32L151xx and STM32L152xx microcontrollers. For convenience, these will be referred to as STM32L15xxx in the rest of this document unless otherwise specified.

The STM32L15xxx embedded Flash memory can be programmed using in-circuit programming or in-application programming.

The **in-circuit programming (ICP)** method is used to update the entire contents of the Flash memory, using the JTAG, SWD protocol or the boot loader to load the user application into the microcontroller. ICP offers quick and efficient design iterations and eliminates unnecessary package handling or socketing of devices.

In contrast to the ICP method, **in-application programming (IAP)** can use any communication interface supported by the microcontroller (I/Os, USB, UART, I^2C, SPI, etc.) to download programming data into memory. IAP allows the user to re-program the Flash memory while the application is running. Nevertheless, part of the application has to have been previously programmed in the Flash memory using ICP.

The Flash interface implements instruction access and data access based on the AHB protocol. It implements a prefetch buffer that speeds up CPU code execution. It also implements the logic necessary to carry out Flash memory operations (Program/Erase). Read/Write protections and option bytes are also implemented.

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Glossary

This section gives a brief definition of acronyms and abbreviations used in this document:

- The Cortex-M3 core integrates two debug ports:
  - JTAG debug port (JTAG-DP) provides a 5-pin standard interface based on the Joint Test Action Group (JTAG) protocol.
  - SWD debug port (SWD-DP) provides a 2-pin (clock and data) interface based on the Serial Wire Debug (SWD) protocol.
    For both the JTAG and SWD protocols please refer to the *ARM CoreSight on-chip trace and debug documentation*
- Word: data/instruction of 32-bit length
- Half word: data/instruction of 16-bit length
- Byte: data of 8-bit length
- Double word: data of 64-bit length
- Page: 64 words of program memory
- Sector: 16 pages (write protection granularity)
- IAP (in-application programming): IAP is the ability to re-program the Flash memory of a microcontroller while the user program is running.
- ICP (in-circuit programming): ICP is the ability to program the Flash memory of a microcontroller using the JTAG protocol, the SWD protocol or the boot loader while the device is mounted on the user application board.
- I-Code: this bus connects the Instruction bus of the Cortex-M3 core to the Flash instruction interface. Prefetch is performed on this bus.
- D-Code: this bus connects the D-Code bus (literal load and debug access) of the Cortex-M3 to the Flash Data Interface.
- Option bytes: product configuration bits stored in Flash memory
- OBL: option byte loader.
- AHB: advanced high-performance bus.
- CPU (central processing unit): this term stands for the Cortex-M3 core.

1 Introduction

The Flash memory interface manages CPU AHB I-Code and D-Code accesses to the 132 Kbyte memory module (128 Kbyte Program memory + 4 Kbyte Data EEPROM). It implements the erase and program memory operations and the read and write protection mechanisms.

The Flash memory interface accelerates code execution with a system of instruction prefetch.

2 Main features

- Up to 132/ Kbytes total storage capacity
- Memory organization:
  - Up to 128 Kbytes of program memory
  - Up to 4 Kbytes of data EEPROM
  - 4 Kbytes of system memory and 16 bytes of option bytes
  - Up to 8 Kbytes of system memory and 64 bytes of option bytes

Flash memory interface (FLITF) features:

- Flash module read operations: read access is performed on 64 or 32 bits
- Flash module program/erase operations
- Read/write protection
- Write access is performed on 32 bits
- Option byte loader
- Low power mode:
  - Flash module in Power down mode when the STM32L15xxx is in Standby mode or Stop mode
  - Flash module can be placed in Power down or Idle mode when the STM32L15xxx is in Sleep mode
  - Flash module can be placed in Power down or Idle mode when the STM32L15xxx is in Run mode

Note: The DMA can only access Flash memory module with read operations.

3 Flash module organization

The memory is organized as a Program memory block, a data EEPROM block of 512 double words and an information block. *Table 1* shows the memory organization.

The program memory block is divided into sectors of 4 Kbytes each, and each sector is further split up into 16 pages of 256 bytes each. The sector is the write protection granularity. The pages are the erase granularity for the program memory block.

The program memory pages can be written using a half page programming or a fast word programming operation.

Data EEPROM can be erased and written by:

- Double word
- Word/ Fast word
- Half word / Fast half word
- Byte / Fast byte

During a write/erase operation to the Flash memory (except Half Page programming or Double-word erase/write), any attempt to read the Flash memory stalls the bus. The read operation is executed correctly once the programming operation is completed. This means that code or data fetches cannot be performed while a write/erase operation is ongoing.

For more details, refer to *Section 4.2: Erasing memory on page 13* and *Section 4.3: Programming memory on page 14*.

Note: Code execution is not possible from Data EEPROM.

Table 1. Flash module organization

Block	Name		Memory addresses	Size
Program memory	Sector 0	Page 0	0x0800 0000 - 0x0800 00FF	256 bytes
		Page 1	0x0800 0100 - 0x0800 01FF	256 bytes
		Page 2	0x0800 0200 - 0x0800 02FF	256 bytes
		Page 3	0x0800 0300 - 0x0800 03FF	256 bytes
		Page 4 to 7	0x0800 0400 - 0x0800 07FF	1 Kbytes
		Page 8 to 11	0x0800 0800 - 0x0800 0BFF	1 Kbyte
		Page 12 to 15	0x0800 0C00 - 0x0800 0FFF	1 Kbyte
	Sector 1		0x0800 1000 - 0x0800 1FFF	4 Kbytes
	Sector 2		0x0800 2000 - 0x0800 2FFF	4 Kbytes
	Sector 3		0x0800 3000 - 0x0800 3FFF	4 Kbytes
	. . .		. . .	. . .
	Sector 30		0x0801 E000 - 0x0801 EFFF	4 Kbytes
	Sector 31		0x0801 F000 - 0x0801 FFFF	4 Kbytes

Table 1. Flash module organization (continued)

Block	Name		Memory addresses	Size
Data memory / EEPROM	DATA		0x0808 0000 - 0x0808 0FFF	4096 bytes
Information block	System memory	Page 0	0x1FF0 0000 - 0X1FF0 00FF	256 bytes
		Page 1	0x1FF0 0100 - 0X1FF0 01FF	256 bytes
		Page 2	0x1FF0 0200 - 0X1FF0 02FF	256 bytes
		Page 3	0x1FF0 0300 - 0X1FF0 03FF	256 bytes
		. . .	. . .	. . .
		Page 15	0x1FF0 0F00 - 0X1FF0 0FFF	256 bytes
	Option bytes block: OPTB		0x1FF8 0000 - 0X1FF8 000F	16 bytes

4 Memory operations

4.1 Unlocking/locking memory

Program and erase operations are managed by the FLITF.

The following blocks can be separately locked or unlocked:

- Data EEPROM with the PECR register
- Program memory
- Option bytes

The steps required for each operation are described in the sections below:

4.1.1 Unlocking the Data EEPROM block and the FLASH_PECR register

After reset, Data EEPROM block and the Program/erase control register (FLASH_PECR) are not accessible in write mode and the PELOCK bit in FLASH_PECR is set. The same unlocking sequence unprotects them both at the same time.

The following sequence is used to unlock the Data EEPROM block and FLASH_PECR register:

- Write PEKEY1= 0x89ABCDEF to the Program/erase key register (FLASH_PEKEYR)
- Write PEKEY2= 0x02030405 to the Program/erase key register (FLASH_PEKEYR)

Any wrong key sequence will lock up the Data EEPROM block and the FLASH_PECR register until the next reset, and return a bus error (Cortex-M3 hardfault or Busfault). So a bus error is returned in any of the three cases below:

- after the first write access if the entered PEKEY1 value is erroneous
- during the second write access if PEKEY1 is correctly entered but the PEKEY2 value does not match
- if there is any attempt to write a third value to PEKEYR

When properly executed, the unlocking sequence clears the PELOCK bit in the FLASH_PECR register.

To lock the FLASH_PECR and the data EEPROM again, the software only needs to set the PELOCK bit in FLASH_PECR.

4.1.2 Unlocking the program memory

An additional protection is implemented to write to the program memory (in pages not write-protected (WRP)).

After reset, the program memory is not accessible in write mode: the PRGLOCK bit is set in FLASH_PECR. Write access to the program memory is granted again by clearing the PRGLOCK bit.

The following sequence is used to unlock the program memory:

- Unlock the FLASH_PECR register (see *Section 4.1.1*)
- Write PRGKEY1= 0x8C9DAEBF to the Program memory key register (FLASH_PRGKEYR)
- Write PRGKEY2= 0x13141516 to the Program memory key register (FLASH_PRGKEYR)

Any wrong key sequence will lock up PRGLOCK in FLASH_PECR until the next reset, and return a bus error (Cortex-M3 hardfault or Busfault). So a bus error is returned in any of the three cases below:

- after the first write access if the entered PRGKEY1 value is erroneous
- during the second write access if PRGKEY1 is correctly entered but the PRGKEY2 value does not match
- if there is any attempt to write a third value to PRGKEYR

When properly executed, the unlocking sequence clears the PRGLOCK bit and the program memory is write accessible.

To lock the program memory again, the software only needs to set the PRGLOCK bit in FLASH_PECR.

4.1.3 Unlocking the option byte block

An additional write protection is implemented on the option byte block.

After reset, the option bytes are not accessible in write mode: the OPTLOCK bit in FLASH_PECR is set. Write access to the option bytes is granted again by clearing OPTLOCK.

The following sequence is used to unlock the option byte block:

- Unlock the FLASH_PECR register (see *Section 4.1.1*)
- Write OPTKEY1= 0xFBEAD9C8 to the Option key register (FLASH_OPTKEYR)
- Write OPTKEY1= 0x24252627 to the Option key register (FLASH_OPTKEYR)

Any wrong key sequence will lock up OPTLOCK in FLASH_PECR until the next reset, and return a bus error (Cortex-M3 hardfault or Busfault). So a bus error is returned in any of the three cases below:

- after the first write access if the entered OPTKEY1 value is erroneous
- during the second write access if OPTKEY1 is correctly entered but the OPTKEY2 value does not match
- if there is any attempt to write a third value to OPTKEYR

When properly executed, the unlocking sequence clears the OPTLOCK bit and the option bytes are write accessible.

To lock the option byte block again, the software only needs to set the OPTLOCK bit in FLASH_PECR.

4.2 Erasing memory

Different erase operations are available for Program memory and Data EEPROM because they have different granularity. These operations are:

- **Data EEPROM:** word and double word erase
- **Program memory:** page erase (
- **Mass erase:** This erases the Program memory, Data EEPROM and Option bytes in both banks in a single operation.

To erase and program a page, an erase operation followed by 2 half page programming operations are required.

4.2.1 Data EEPROM erase

This operation is used to erase a in Data EEPROM. To do so:

- Unlock the Data EEPROM and the FLASH_PECR register
- Write a word to a valid address in data EEPROM with the value 0x0000 0000
- This activates an erase phase

4.2.2 Data EEPROM double word erase

This operation is used to erase a double word in Data EEPROM.

To do so:

- Unlock the Data EEPROM and the FLASH_PECR register
- Set the ERASE bit in the FLASH_PECR register
- Set the DATA bit in the FLASH_PECR register to erase a data double word
- Wait for the BSY bit to be cleared
- Write 0x0000 0000 to each of the two data words to be erased

Warning: Data EEPROM double word erase is possible only from SRAM or from Bank 1 to Bank 2 and vice versa.

4.2.3 Program memory page erase

This operation is used to erase a page in program memory (64 words). To do so:

- Unlock the FLASH_PECR register
- Unlock the Program memory
- Set the ERASE bit in the FLASH_PECR register
- Set the PROG bit in the FLASH_PECR register to choose program page
- Wait for the BSY bit to be cleared
- Write 0x0000 0000 to the first word of the program page to erase

4.3 Programming memory

4.3.1 Program memory Fast Word Write

This operation is used to write a word to the program memory, assuming that it was previously erased. To do so:

- Unlock the FLASH_PECR register
- Unlock the Program memory
- Write a word to a valid address in the program memory. This activates a programming phase.

4.3.2 Program memory Half Page Write

This operation is used to write half a page to the program memory (32 words). To do so:

- Unlock the FLASH_PECR register
- Unlock the program memory
- Set the FPRG bit in the FLASH_PECR register (this configures FLASH_PECR to perform a data buffer loading sequence)
- Set the PROG bit in the FLASH_PECR register to access the required program memory page
- Wait for the BSY bit to be cleared
- Directly write half a page with 32 different words to the program memory address space. The words must be written sequentially starting from word 0 and ending with word 31

Warning: Half page write is possible only from SRAM or from Bank 1 to Bank 2 and vice versa.

Note: If there are more than 32 words to write, after 32 words another Half Page programming operation starts and has to be finished.

4.3.3 Data EEPROM double Word Write

This operation is used to write a double word to the data EEPROM. To do so:

- Unlock the Data EEPROM and the FLASH_PECR register
- Set the FPRG bit in the FLASH_PECR register (this configures FLASH_PECR to perform a data buffer loading sequence)
- Set the DATA bit in the FLASH_PECR register to access the required data EEPROM page
- Wait for the BSY bit to be cleared
- Directly write a double word by writing 2 different words to the data EEPROM address space. The words must be written sequentially starting from word 0 and ending with word 1.

Warning: Data EEPROM double word write is possible only from SRAM or from Bank 1 to Bank 2 and vice versa.

Note: A data EEPROM double word is written to the data EEPROM only if the first address to load is the start address of a double word (multiple of double word).

4.3.4 Data EEPROM Fast Word Write

This operation is used to write a word to the data EEPROM assuming that it was previously erased. The time taken for this operation is 1 tprog (see *Table 6 on page 23* for more details).

- Unlock the Data EEPROM and the FLASH_PECR register
- Clear the FTDW bit (FLASH_PECR[8]) assuming that the word is already erased (0x00000000).
- Write a word to a valid address in the data EEPROM
- The following operations are then performed automatically by the Flash memory interface:
  - The Flash memory interface addresses and reads the word to be written to
  - A ECC is calculated for the new word to write to the memory
  - A write operation is immediately executed (the word read by the interface must be 0x00000000 and the FTDW bit must be cleared)

4.3.5 Data EEPROM Word Write

This operation is used to write a word to the data EEPROM whatever the previous value of the word to be written to. The time taken for this is 1 or 2 tprog, depending on the FTDW bit (see *Table 6 on page 23* for more details).

- Unlock the Data EEPROM and the FLASH_PECR register
- Configure (Set/Clear) the FTDW bit (FLASH_PECR[8]) to execute Word Write, whatever the previous value of the word be written to
- Write a word to a valid address in the data EEPROM
- The following operations are then performed automatically by the Flash memory interface:
  - The Flash memory interface addresses and reads the word to be written to
  - A new ECC is calculated for the new word to write to the memory
  - Case 1: FTDW bit = 0:

    If the word read by the interface was not 0x00000000, an erase operation is done automatically followed with a write operation. The time taken for this is 2 tprog.

    If the word read by the interface was 0x00000000, a write operation is immediately executed (it takes the same time as Fast Word Write, 1 tprog).
  - Case 2: FTDW bit = 1:

    If the FTDW bit is set, an erase operation is always done automatically followed by a write operation. The time taken for this is 2 tprog.

4.3.6 Data EEPROM Fast Half Word Write

This operation is used to write a NON NULL[1] half word to the data EEPROM assuming that the complete word was previously erased. The time taken for this is 1 tprog (see *Table 6 on page 23* for more details).

- Unlock the Data EEPROM and the FLASH_PECR register
- Clear the FTDW bit (FLASH_PECR[8]) assuming that the word is already erased (0x00000000)
- Write a half word to a valid address in the data EEPROM
- The following operations are then performed automatically by the Flash memory interface:
  - The Flash memory interface addresses and reads the word to be written to
  - A ECC is calculated for the new half word to write to the memory
  - A write operation is immediately executed (the word read by the interface must be 0x00000000 and the FTDW bit must be cleared)

4.3.7 Data EEPROM Half Word Write

This operation is used to write a NON NULL[1] half word to the data EEPROM whatever the previous value of the word to be written to. The time taken for this is 1 or 2 tprog, depending on the FTDW bit (see *Table 6 on page 23* for more details).

- Unlock the Data EEPROM and the FLASH_PECR register
- Configure (Set/Clear) the FTDW bit (FLASH_PECR[8]) to execute half Word Write, whatever the previous value of the half word to be written to
- Write a half word to a valid address in the data EEPROM
- The following operations are then performed automatically by the Flash memory interface:
  - The Flash memory interface addresses and reads the word to be written to
  - A new ECC is calculated for the new half word to write to the memory
  - Case 1: FTDW bit = 0:

    If the word read by the interface was not 0x00000000, an erase operation is done automatically followed by a write operation. The time taken for this is 2 tprog.

    If the word read by the interface was 0x00000000, a write operation is immediately executed (it takes the same time as Fast half word Write, 1 tprog).
  - Case 2: FTDW bit = 1:

    An erase operation is always done automatically followed by a write operation. The time taken for this is 2 tprog.

1. This restriction applies only for medium density devices.

4.3.8 Data EEPROM Fast Byte Write

This operation is used to write a NON NULL Byte to the data EEPROM assuming that the complete word was previously erased. The time taken for this is 1 tprog (see *Table 6 on page 23* for more details).

- Unlock the Data EEPROM and the FLASH_PECR register
- Clear the FTDW bit (FLASH_PECR[8]) assuming that the word is already erased (0x00000000).
- Write a byte to a valid address in the data EEPROM
- The following operations are then performed automatically by the Flash memory interface:
  - The Flash memory interface addresses and reads the word to be written to
  - A new ECC is calculated for the new byte to write to the memory
  - A write operation is immediately executed (the word read by the interface must be 0x00000000 and the FTDW bit must be cleared)

4.3.9 Data EEPROM Byte Write

This operation is used to write a NON NULL[(2)] byte to the data EEPROM whatever the previous value of the word to be written to. The time taken for this is 1 or 2 tprog, depending on the FTDW bit (see *Table 6 on page 23* for more details).

- Unlock the Data EEPROM and the FLASH_PECR register
- Configure (Set/Clear) the FTDW bit (FLASH_PECR[8]) to execute byte Write, whatever the previous value of the word to write to
- Write a NON NULL byte to a valid address in the data EEPROM
- The following operations are then performed automatically by the Flash memory interface:
  - The Flash memory interface addresses and reads the word to be written to
  - A new ECC is calculated for the new byte to write to the memory
  - Case 1: FTDW bit = 0:

    If the word read by the interface was not 0x00000000, an erase operation is done automatically followed by a write operation.The time taken for this is 2 tprog.

    If the word read by the interface was 0x00000000, a write operation is immediately executed (it takes the same time as Fast byte Write, 1 tprog).
  - Case 2: FTDW bit = 1:

    An erase operation is always done automatically followed by a write operation. The time taken for this is 2 tprog.

2. This restriction applies only for medium density devices.

Table 2. Data EEPROM programming times

	FTDW bit	Word erase state	Programming time	Comments
Data EEPROM **Fast Word/Half Word/Byte** Write	0	Word previously erased	1 Tprog	User software has already erased the selected word using the Data EEPROM double word/word erase
Data EEPROM **Word/Half Word/Byte** Write	0	Word previously erased	1 Tprog	The word read by the interface is 0x0 ==> no need for erase, this case is equal to Fast Word/Half Word/Byte write
	0	Word not erased	2 Tprog	The word read by the interface is not 0x0 ==> an erase is done automatically
	1	Word previously erased or word not erased	2 Tprog	An erase is done automatically whatever the word read by the interface (ECC module)

Note: 1 When programming a Data Word, Data Half-word or Data byte from Program memory, the DCode and ICode are locked for a duration of 1 to 3 tprog. After the end of programming, the code execution resumes. To avoid this behavior, the write operation has to be executed from SRAM.

2 When programming Data Word or Data Half-word at non-aligned addresses, the write operation may take more than 1 tprog time.

3 During the Program memory half page write, Data EEPROM double word erase and Data EEPROM double word write, all read operations are forbidden (this includes DMA read operations and debugger read operations such as breakpoints, periodic updates, etc.)

4 If a PGAERR is set during a Program memory half page write or Data EEPROM double word write, the complete write operation is aborted. Software should then reset the FPRG and PROG/DATA bits and restart the write operation from the beginning.

4.3.10 Alignment error flag

The Flash memory interface checks three kinds of alignment:

- A half page is written to the program memory only if the first address to load is the start address of a half page (multiple of 128 bytes) and the 31 remaining words to load are in the same half page.
- A double word is written to the data EEPROM only if the first address to load is the start address of a double word (multiple of 8 bytes)
- Change of page is not possible during half page programming

If the alignment check is not correct, the PGAERR flag (FLASH_SR[8]) is set and an interrupt can be generated. The programming operation aborts.

4.3.11 Size error flag

During the write and erase procedures, the Flash memory interface checks the data size to verify the coherence between the size of the data to write and the allowed operations.

Table 3. Prohibited operations

Memory block	Data size
Program memory	Byte/Half-Word Write prohibited Byte/Half-Word/Word Erase prohibited
Option byte block	Byte/Half Word prohibited

If the check is not correct, a flag **SIZERR** (FLASH_SR[9]) is set and a interrupt can be generated.

4.3.12 Bus error (Cortex-M3 hardfault or Busfault)

A bus error (Cortex-M3 hardfault or Busfault) is returned in two cases:

- When read access through D bus or I bus is performed when memory is read protected and while the debug features are connected or boot is executing from SRAM.
- Wrong DATA EEPROM/FLASH_PECR register/Program memory/Option Bytes unlock sequence. Refer to *Section 4.1: Unlocking/locking memory* for more details.

5 Option byte description

Part of the Flash memory module is reserved for the storage of a set of option bytes. These option bytes contain information on the configuration of the product and they are configured according to the end application requirements. As a configuration example, you can select the watchdog in hardware or software mode.

In the option byte block, a 32-bit word is mapped as shown in the table below.

31 30 29 28 27 26 25 24	23 22 21 20 19 18 17 16	15 14 13 12 11 10 9 8	7 6 5 4 3 2 1 0
Complemented option byte1	Complemented option byte0	Option byte 1	Option byte 0

The organization of the bytes inside the option block is as shown in *Table 4*.

Table 4. Option byte organization

Address	[31:24]	[23:16]	[15:8]	[7:0]
0x1FF80000	-	nRDP	-	RDP
0x1FF80004	-	nUSER	-	USER
0x1FF80008	nWRP1	nWRP0	WRP1	WRP0
0x1FF8000C	nWRP3	nWRP2	WRP3	WRP2

Option byte loading is performed in two cases:

- When OBL_LAUNCH is set (in this case, a reset is generated)
- After every power-up of the V 18 domain (that is after POR or after Standby)

The option byte loader (OBL) reads the information block and stores the data into the option byte register (FLASH_OBR).

During the option byte loading process, it is possible to check that the loading operation was successful by verifying an option byte and its complement.

If the verification fails, the OPTVERR status bit is set and an interrupt is generated if ERRIE is set.

The option byte registers are accessible in read mode by the CPU. See “Flash option byte register” section in the *STM32L151xx and STM32L152xx reference manual (RM0038)* for more details.

Table 5. Description of the option bytes

Memory address	Option bytes
0x1FF8 0000	Bits [23:16]: **nRDP** Bits [7:0]: **RDP:** Read protection option byte (stored in FLASH_OBR[22:16]) The read protection is used to protect the software code stored in Flash memory. 0xAA: Level 0, no protection 0xCC: Level 2, chip protection (debug and boot in SRAM features disabled) Others: Level 1, read protection of memories (debug features limited)
0x1FF8 0004	Bits [23:16] **nUSER** Bits [7:0] **USER:** User option byte (stored in FLASH_OBR[7:0]) This byte is used to configure the following features: – Select the brownout reset threshold level – Select the watchdog event: Hardware or software – Reset event when the CPU enters the Stop mode – Reset event when the CPU enters the Standby mode Bits 3:0: **BOR_LEV[3:0]:** Brownout reset threshold level Bit 4: **IWDG_SW** 0: Hardware independent watchdog 1: Software independent watchdog Bit 5: **nRST_STOP** 0: Reset generated when the CPU enters the Stop mode 1: No reset generated Bit 6: **nRST_STDBY** 0: Reset generated when the CPU enters the Standby mode 1: No reset generated
0x1FF8 0008	**WRPx**: Memory write protection option bytes Bits [31:24]: **nWRP1** Bits [23:16]: **nWRP0** Bits [15:8]: **WRP1** (stored in FLASH_WRPR[15:8]) Bits [7:0]: **WRP0** (stored in FLASH_WRPR[7:0]) 0: Write protection not active on selected sector 1: Write protection active on selected sector
0x1FF8 000C	**WRPx**: Memory write protection option bytes Bits [31:24]: **nWRP3** Bits [23:16]: **nWRP2** Bits [15:8]: **WRP3** (stored in FLASH_WRPR[31:23]) Bits [7:0]: **WRP2** (stored in FLASH_WRPR[23:16]) 0: Write protection not active on selected sector 1: Write protection active on selected sector

5.1 Option byte block programming

Only Fast Word Write, Word Write and Word Erase are possible in the option byte block.

The option bytes are not programmed in the same way as program/data EEPROM addresses.

Two unlock sequences are required:

- Unlock the FLASH_PECR register
- Unlock the option byte block

To modify the option bytes, the following steps are mandatory:

- The two option bytes of a given word must be written at the same time.
- The two complementary option bytes of a given word must be calculated and written at the same time (see *Section 5: Option byte description on page 20* for details on the mapping of the option bytes in a 32-bit word)
- The user can write to the option bytes to configure them depending on his requirements.
- To automatically update them in the option byte registers by option byte loading, the OBL_LAUNCH in the FLASH_PECR register should be set and a system reset is generated.
- Option byte error flags should be cleared to be able to program a new option byte.

The following table summarizes the program and erase functions.

Note: The Option bytes are only loaded when they are already programmed correctly with the corresponding complementary bytes.

6 Quick reference to programming/erase functions

Table 6. Programming/erase functions

	Operation	Block	Bit/procedure	Time
Erase operation	Word erase (1)	Data EEPROM Option bytes	Write directly the value 0x0000 0000 into the address	1 tprog
	Page Erase (2)	Program memory	ERASE = 1 PROG = 1	1 tprog
	Double Word Erase (3) (4)	Data EEPROM	FPRG = 1 DATA = 1	1 tprog
	Mass Erase	Program memory +Data EEPROM + Option bytes + backup registers (in RTC)	RDP: level1 -> level0	2 tprog for erase + 1 tprog for program
Write operation	Fast Word Write	Program memory Data EEPROM Option bytes	FTDW = 0	1 tprog
	Word Write (5)	Data EEPROM Option bytes	FTDW = 1 or 0	1 or 2 tprog
	Half Page Write (3) (6)	Program memory	FPRG = 1 PROG = 1	1 tprog
	Double Word Write (3)(4)	Data EEPROM	FPRG = 1 DATA = 1	1 tprog
	Fast Byte Write (7) Fast Half Word Write (7)(5)	Data EEPROM	FTDW = 0	1tprog
	Byte Write (7) Half Word Write(7)(5)	Data EEPROM	FTDW = 1 or 0	1 or 2 tprog

1. A data EEPROM word is erased in the data EEPROM only if the address to load is the start address of a word (multiple of a word).
2. A Page is erased in the Program memory only if the address to load is the start address of a page (multiple of 256 bytes).
3. The Half Page Write, Double Word Erase and Double Word Write are possible only from SRAM.
4. A data EEPROM double word is written or erased to the data EEPROM only if the first address to load is the start address of a double word (multiple of double word).
5. When programming Data Word or Data Half-word at non-aligned addresses, the write operation may take more than 1 tprog time.
6. A half page is written to the program memory only if the first address to load is the start address of a half page (multiple of 128 bytes)
7. The Fast Byte Write, Fast Half Word Write, Byte Write and Half Word Write can be used only to write a NON NULL byte/half word

7 Memory protection

The Flash memory module can be protected against read accesses.

The memory sectors can also be individually protected against unwanted write accesses caused by loss of program counter contexts.

7.1 Readout protection (RDP) of the program and data EEPROMs

The user area of the Flash memory module (data and program) can be protected against read operations. Three read protection levels are defined:

- Level 0: no read protection

  When the read protection level is set to Level 0 by writing 0xAA to the read protection option byte, RDP, all read/write operations (if no write protection is set) from/to the Flash memory module or the backup SRAM are possible in all boot configurations (Flash user boot, debug or boot SRAM).

7.1.1 Level 1: memory read protection enabled

This is the default read protection level after option byte erase. Read protection Level 1 is activated by writing any value (except for 0xAA and 0xCC used to set Level 0 and level 2, respectively) to the RDP option byte. When read protection Level 1 is set:

- No Flash memory module access (read, erase, program) is performed while the debug features are connected or boot is executed from SRAM. A bus error (Cortex-M3 hardfault or Busfault) is generated in case of a Flash memory read request. All operations are possible when Flash user boot is used.
- Programming the protection option byte first causes the Flash memory module and the backup registers (in RTC) to be mass-erased. That is, the user code contents are cleared before the read protection is removed.
- The Flash memory module is also write-protected if the CPU debug features (JTAG or single-wire) are connected or if boot from SRAM is selected.

Note: When Level 1 is active and Level 0 is requested, the following steps are executed:

- *Mass Erase is generated (RDP byte is erased (0x0) and Level 1 is still active and no more code could be executed)".*
- *If the OBL Launch is set or a System reset is generated, the new RDP byte is loaded (0xAA) and Level 0 is active.*

Note: Mass Erase is performed only when Level 1 is active and Level 0 is requested. When the protection level is increased (0->1, 1->2, 0->2) there is no Mass Erase.

- The Flash memory module is also write-protected if the CPU debug features (JTAG or single-wire) are connected or if boot from SRAM is selected.

7.1.2 Level 2: memory read protection enabled and all debug features disabled

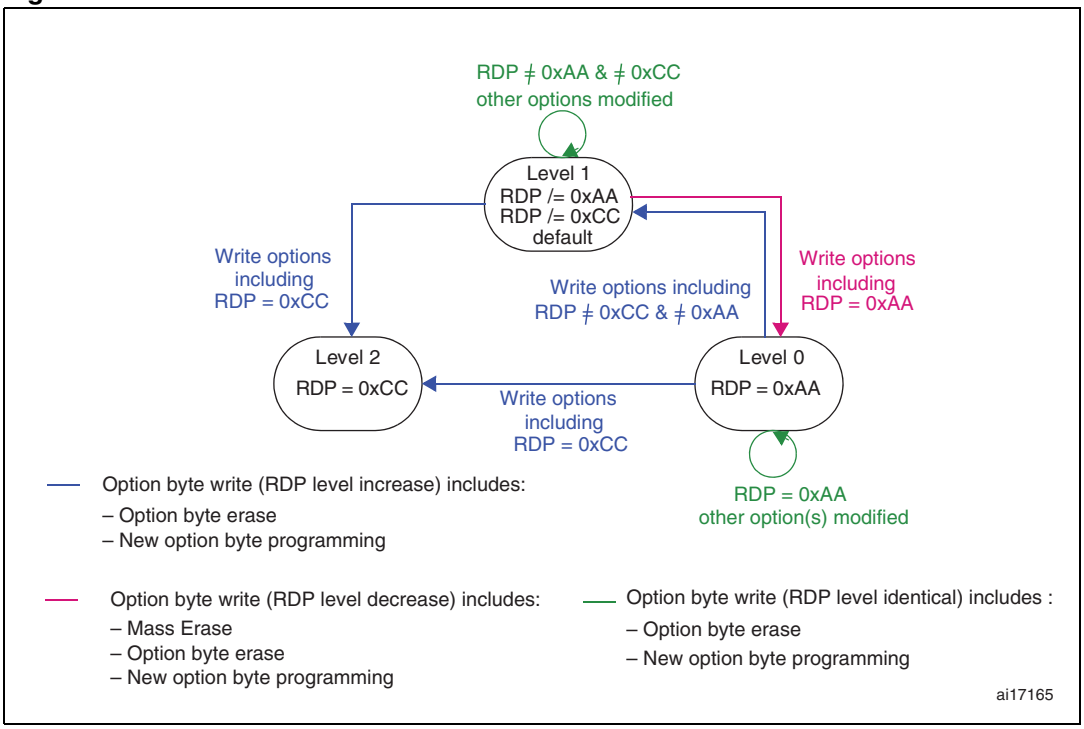
Note: Memory read protection Level 2 is an irreversible operation. The level of protection in this case cannot be decreased to level 0 or level 1.

When read protection Level 2 is activated by writing 0xCC to the RDP option byte, all protections provided by Level 1 are active, system memory and all debug features (CPU JTAG and single-wire) are disabled when booting from SRAM or from system memory and user options can no longer be changed.

Note: The JTAG port is permanently disabled in level 2 (acting as a JTAG fuse). Consequently, boundary scan cannot be performed. STMicroelectronics is not able to perform analysis on defective parts on which the level 2 protection has been set.

Figure 1: RDP levels shows how to go from one RDP level to another.

Figure 1. RDP levels



The Flash memory module is protected when the RDP option byte and its complement contain the following pair of values:

Table 7. Flash memory module protection according to RDP and its complement

RDP byte value	RDP's complementary value	Read protection status
0xAA	0x55	Level 0
0xCC	0x33	Level 2
Any value	Complement of RDP byte	Level 1
Any value	Not the complement value of RDP	Level 1

7.2 Write protection (WRP) of the program memory

The write protection granularity is the sector (16 pages). This means that only 32 option bits are needed to protect the whole 128 Kbyte program memory.

Note: When the memory read protection level is selected (RDP level = 1), it is not possible to program or erase the program and data EEPROMs if the CPU debug features are connected (JTAG or Single Wire) or boot code is executed from SRAM, even if nWRPi = 0.

The data EEPROM is not protected by WRP bits.

7.3 Write protection error flag

If an erase/program operation to a write-protected memory page is launched, the write protection error flag (WRPERR) is set in the FLASH_SR register. This flag is set whenever the software attempts to write to any protected address.

Consequently, the WRPERR flag is set when the software tries to write to:

- a write protected page
- a System memory page
- the Program memory, Data EEPROM or option byte block if they are **not** unlocked by PEKEY, PRGKEY or OPTKEY
- the Data EEPROM and Program memory when the RDP option byte is set and the device is in debug mode or is booting from SRAM.

8 Interrupts

Setting the end of programming interrupt enable bit (EOPIE) in the FLASH_PECR register enables an interrupt generation when an erase or program operation successfully ends. In this case, the end of programming (EOP) bit in the FLASH_SR register is set.

Setting the error interrupt enable bit (ERRIE) in the FLASH_PECR register enables an interrupt generation if an error occurs during a program or erase operation, or during option byte loading. In this case, one of the error flags is set in the FLASH_SR register:

- WRPERR (write protection error flag)
- PGAERR (programming alignment error flag)
- OPTVERR (option validity error flag)
- SIZERR (size error flag)

Table 8. Interrupts

Interrupt event	Event flag	Enable control bit
End of programming	EOP	EOPIE
Error	WRPERR PGAERR OPTVERR SIZERR	ERRIE

9 Register description

9.1 Access control register (FLASH_ACR)

Address offset: 0x00

Reset value: 0x0000 0000

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Reserved																											RUN_PD	SLEEP_PD	ACC64	PRFTEN	LATENCY
																											rw	rw	rw	rw	rw

Bits 31:5 Reserved, must be kept cleared.

Bit 4 **RUN_PD:** Power saving mode during Run

This bit can be written only when it is unlocked by writing to FLASH_PDKEYR.
This bit determines whether the Flash memory module is in Power down mode or Idle mode when the STM32L15xxx is in Run mode.
The Flash memory module can be placed in Power down mode only when the code is executed from SRAM).
0: Flash module in Idle mode
1: Flash modulein Power down mode

Bit 3 **SLEEP_PD:** Power saving mode during Sleep

This bit is used to put the Flash memory module in Power down mode or Idle mode when the STM32L15xxx is in Sleep mode.
0: Flash module in Idle mode
1: Flash module in Power down mode

Bit 2 **ACC64**: 64-bit access

This bit is used to read data from the memory 64 bits or 32 bits at a time. 32-bit access is used to decreases the memory consumption. On the contrary, 64-bit access is used to improve the performance. In this case it is useful to enable prefetch.
0: 32-bit access
1: 64-bit access

Note: 32-bit access is a low power mode. It is used only at low frequencies, that is with 0 wait state of latency and prefetch off.

Note: This bit cannot be written at the same time as the LATENCY and PRFTEN bits.

Bit 1 **PRFTEN**: Prefetch enable

0: prefetch disabled
1: prefetch enabled

*Note: Prefetch can be enabled only when **ACC64** is set.*
This bit can be set or cleared only if ACC64 is set.

Bit 0 **LATENCY**: Latency

This bit represents the ratio of the CPU clock period to the memory access time.
0: zero wait state
1: one wait state

Note: Latency can be set only when ACC64 is set.
This bit can be set or cleared only if ACC64 is set.

9.2 Program/erase control register (FLASH_PECR)

This register is used to perform all erase and program operations. It is write-accessible only after the good write sequence has been executed in FLASH_PEKEYR.

Address offset: 0x04

Reset value: 0x0000 0007

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Reserved													OBL_LAUNCH	ERRIE	EOPIE	Reserved					FPRG	ERASE	FTDW	Reserved			DATA	PROG	OPTLOCK	PRGLOCK	PELOCK
													rw1	rw	rw						rw	rw	rw				rw	rw	rs	rs	rs

Bits 31:19 Reserved, must be kept cleared.

Bit 18 **OBL_LAUNCH:** Launch the option byte loading

This bit is set by software to launch the option byte loading. This bit is cleared only when the option byte loading has completed. It cannot be written if OPTLOCK is set.

When this bit is set, a reset is generated.

0: Option byte loading complete

1: Option byte has to be loaded

Bit 17 **ERRIE**: Error interrupt enable

0: interrupt disabled

1: interrupt enabled

Bit 16 **EOPIE**: End of programming interrupt enable

0: interrupt disabled

1: interrupt enabled

Bits 15:11 Reserved, must be kept cleared.

Bit 10 **FPRG**: Half Page/Double Word programming mode

This bit can be written by software when no program or erase process is ongoing.

It is used to enable/disable Half Page Programming to the program memory or Double Word Programming to the data EEPROM.

32 loadings are required to program half a page to the program memory.

2 loadings are required to program a double word to the data EEPROM.

This bit is cleared when PELOCK is set.

0: Half Page/Double Word programming disabled

1: Half Page/Double Word programming enabled

Bit 9 **ERASE**: Page or Double Word erase mode

This bit can be written by software when no program or erase process is on going.

It is used to enable/disable Page Erase on the program memory or Double Word Erase on the data EEPROM and the option byte block.

This bit is cleared when PELOCK is set.

0: Page or Double Word Erase disabled

1: Page or Double Word Erase enabled

Bit 8 **FTDW:** Fixed time data write for Byte, Half Word and Word programming

This bit is writable by software when no program or erase process is ongoing.
This bit is used for the data EEPROM only.
It is cleared when PELOCK is set.
0: Programming of a Byte, Half Word or wordis performed without any previous erase operation. This is possible if the word being written to is 0x0000 0000
1: Before the programming of a Byte, Half Word and word an erase phase is automatically performed. So the time of programming is fixed and lasts two t_{prog}

Bits 7:5 Reserved, must be kept cleared

Bit 4 **DATA**: Data EEPROM selection

This bit is writable by software when no program or erase process is ongoing.
This bit has to be set prior to data EEPROM double word erase/programming.
This bit is cleared when PELOCK is set.
0: Data EEPROM not selected
1: Data EEPROM selected

Bit 3 **PROG**: Program memory selection

This bit is writable by software when no program or erase process is ongoing.
This bit has to be set to gain access to the program memory, except in the case of word programming.
This bit is cleared when PELOCK is set.
0: Program memory not selected
1: Program memory selected

Bit 2 **OPTLOCK**: Option bytes block lock

This bit can only be written to 1. When it is set, it indicates that the option byte block is locked.
It is cleared by hardware after detecting the unlock sequence. In the event of an unsuccessful unlock operation or a third access to OPTKEYR, a bus error (Cortex-M3 hardfault or Busfault) is generated and this bit remains set until the next reset.
This bit is set when PELOCK is set.
0: option unlocked
1: option locked

Bit 1 **PRGLOCK**: Program memory lock

This bit can only be written to 1. When it is set, it indicates that the program memory cannot be written. It is cleared by hardware after detecting the unlock sequence. In the event of an unsuccessful unlock operation or a third access to PRGKEYR, a bus error (Cortex-M3 hardfault or Busfault) is generated and this bit remains set until the next reset.
This bit is set when PELOCK is set.
0: program memory unlocked
1: program memory locked

Bit 0 **PELOCK**: FLASH_PECR and data EEPROM lock

This bit can only be written to 1. When it is set, it indicates that the FLASH_PECR register and data EEPROM are locked. It is cleared by hardware after detecting the unlock sequence. In the event of unsuccessful unlock operation or a third access to PEKEYR, a bus error (Cortex-M3 hardfault or Busfault) is generated and this bit remains set until the next reset.
When this bit is cleared, write access to the data EEPROM is allowed.
0: FLASH_PECR is unlocked
1: FLASH_PECR is locked

9.3 Power down key register (FLASH_PDKEYR)

The Power down key register is used to unlock the RUN_PD bit in FLASH_ACR.

Address offset: 0x08

Reset value: 0x0000 0000

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PDKEYR[31:0]																															
w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w

Bits 31:0 **PDKEYR[31:0]**: RUN_PD in FLASH_ACR key

These bits represent the keys used to set the RUN_PD bit in the FLASH_ACR register.
PDKEY1: 0x04152637
PDKEY2: 0xFAFBFCFD

9.4 Program/erase key register (FLASH_PEKEYR)

The Program/erase key register is used to allow access to FLASH_PECR and so, to allow program and erase operations in the data EEPROM.

Address offset: 0x0C

Reset value: 0x0000 0000

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PEKEYR[31:0]																															
w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w

Bits 31:0 **PEKEYR[31:0]**: FLASH_PEC and data EEPROM key

These bits represent the keys to unlock the write access to the FLASH_PECR register and data EEPROM.
PEKEY1: 0x89ABCDEF
PEKEY2: 0x02030405

9.5 Program memory key register (FLASH_PRGKEYR)

The Program memory key register is used to allow program and erase operations in the Program memory. It is write accessible only after a correct write sequence has been executed in FLASH_PEKEYR.

Address offset: 0x10

Reset value: 0x0000 0000

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PRGKEYR[31:0]																															
w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w

Bits 31:0 **PRGKEYR[31:0]**: Program memory key

These bits represent the keys to unlock the program memory.
PRGKEY1: 0x8C9DAEBF
PRGKEY2: 0x13141516

9.6 Option byte key register (FLASH_OPTKEYR)

The Option key register is used to allow program and erase operations in the option byte block. It is write accessible only after the good write sequence has been executed in FLASH_PEKEYR.

Address offset: 0x14

Reset value: 0x0000 0000

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
OPTKEYR[31:0]																															
w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w	w

Bits 31:0 **OPTKEYR**: Option byte key

These bits represent the keys to unlock the write access to the option byte block.
OPTKEY1:0xFBEAD9C8
OPTKEY2:0x24252627

9.7 Status register (FLASH_SR)

Address offset: 0x18

Reset value: 0x0000 0004

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Reserved																				OPTVERR	SIZERR	PGAERR	WRPERR	Reserved				READY	ENDHV	EOP	BSY
																				rc_w1	rc_w1	rc_w1	rc_w1					r	r	r	r

Bits 31:123 Reserved, must be kept cleared.

Bit 11 **OPTVERR**: Option validity error

Set by hardware when the options read may not be the ones configured by the software.
Cleared by writing 1.
If the options have not been properly loaded, each time a system reset occurs, OPTVERR reverts to logical level 1. Consequently, an interrupt is generated whenever ERRIE is set.

Bit 10 **SIZERR**: Size error

Set by hardware when the size of the data to program is prohibited.
Cleared by writing it to 1.

Bit 9 **PGAERR**: Programming alignment error

Set by hardware when the data to program cannot be contained in a given half page or double word.

Cleared by writing it to 1.

Bit 8 **WRPERR**: Write protected error

Set by hardware when an address to be erased/programmed belongs to a write-protected part of the memory.

Cleared by writing it to 1.

Bits 7:4 Reserved, must be kept cleared.

Bit 3 **READY:** Flash memory module ready after low power mode

This bit is set and cleared by hardware.

0: Flash memory module is not ready

1: Flash memory module is ready

Bit 2 **ENDHV:** End of high voltage

This bit is set and cleared by hardware.

0: High voltage still applied during write/erase operations

1: End of high voltage

Bit 1 **EOP**: End of operation

This bit is set by hardware if the high voltage stops being applied and programming has not been aborted. It is cleared by software (by writing it to 1).

0: No EOP event occurred

1: An EOP event occured. An interrupt is generated if EOPIE is set

Bit 0 **BSY**: Write/erase operations in progress

0: Write/erase operation not in progress

1: Write/erase operation in progress

9.8 Option byte register (FLASH_OBR)

Address offset: 0x1C

Reset value: 0x0078 0000

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
reserved									nRST_STDBY	nRTS_STOP	IWDG_SW	BOR_LEV[3:0]				reserved								RDPRT							
									r	r	r	r	r	r	r									r	r	r	r	r	r	r	r

Bits 31:23 Reserved, must be kept cleared.

Bits 22:16 **User option byte**

These bits contain the user option byte loaded by the OBL.

Bit 22: **nRST_STDBY**

Bit 21: **nRST_STOP**

Bit 20: **IWDG_SW**

Bits 19:16:**BOR_LEV[3:0]:** Brownout reset threshold level

0xxx: BOR OFF: Reset threshold level for the 1.45 V-1.55 V voltage range (power down only)

In this particular case, V_{DD33} must have been above BOR LEVEL 1 to start the device OBL sequence in order to disable the BOR. The power-down is then monitored by the PDR.

Note: If the BOR is disabled, a "grey zone" exists between 1.65 V and the V_{PDR} threshold (this means that V_{DD33} may be below the minimum operating voltage (1.65 V) without causing a reset until it crosses the V_{PDR} threshold)

1000: BOR LEVEL 1: Reset threshold level for 1.69 V-1.8 V voltage range (power on)
1001: BOR LEVEL 2: Reset threshold level for 1.94 V-2.1 V voltage range (power on)
1010: BOR LEVEL 3: Reset threshold level for 2.3 V-2.49 V voltage range (power on)
1011: BOR LEVEL 4: Reset threshold level for 2.54 V-2.74 V voltage range (power on)
1100: BOR LEVEL 5: Reset threshold level for 2.77 V-3.0 V voltage range (power on)
These bits are read only.

Bits 15:8 Reserved, must be kept cleared.

Bits 7:0 **RDPRT[7:0]:** Read protection

These bits contain the read protection option level loaded by the OBL.
0xAA: Level 0, read protection not active
0xCC: Level 2, read protection active
Others: Level 1, read protection of memories active. Default configuration after option byte erase.

9.9 Write protection register (FLASH_WRPR)

Address offset: 0x20

Reset value: 0x0000 0000

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
WRP[31:0]																															
r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r

Bits 31:0 **WRP[n]**: Write protection, where n is the number of the concerned memory sector

These bits contain the write protection option loaded by the OBL
0: sector n not write protected
1: sector n write protected

9.10 Register map

The following table summarizes the register map and reset values.

Table 9. Register map and reset values

Offset	Register	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0x00	**FLASH_ACR**	Reserved																											RUN_PD	SLEEP_PD	Acc64	PRFTEN	LATENCY0
	Reset value: 0x0000 0000																												0	0	0	0	0
0x04	**FLASH_PECR**	Reserved													OBL_launch	ERRIE	EOPIE	Reserved					FPRG	ERASE	FTDW	Reserved			DATA	PRG	OPTLOCK	PRGLOCK	PELOCK
	Reset value: 0x0000 0007														0	0	0						0	0	0				0	0	1	1	1
0x08	**FLASH_PDKEYR**	PDKEYR[31:0]																															
	Reset value: 0x0000 0000	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0x0C	**FLASH_PEKEYR**	PEKEYR[31:0]																															
	Reset value: 0x0000 0000	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0x10	**FLASH_PRGKEYR**	PRGKEYR[31:0]																															
	Reset value: 0x0000 0000	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0x14	**FLASH_OPTKEYR**	OPTKEYR[31:0]																															
	Reset value: 0x0000 0000	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0x18	**FLASH_SR**	Reserved																				OPTVERR	SIZVERR	PGAERR	WRPERR	Reserved			READY	ENDHV	EOP	BSY	
	Reset value: 0x0000 0004																					0	0	0	0				0	1	0	0	
0x1C	**FLASH_OBR**	Reserved									nRST_STDBY	nRST_STOP	IWDG_SW	BOR_LEV [3:0]				Reserved								RDPRT[7:0]								
	Reset value: 0x0078 0000										1	1	1	1	0	0	0									0	0	0	0	0	0	0	0	0
0x20	**FLASH_WRPR**	WRP[31:0]																															
	Reset value: 0x0000 0000	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

10 Revision history

Table 10. Document revision history

Date	Revision	Changes
02-Jul-2010	1	Initial release.
01-Oct-2010	2	“data memory” renamed “data EEPROM” throughout the document. “FTDW bit (FLASH_PECR[11])" replaced with "FTDW bit (FLASH_PECR[8])” throughout the document. Changed document title. Updated *Section 2*, *Table 1*, *Section 3.1.2*, *Section 7.1*. Added *Figure 2*.
22-Nov-2010	3	Modified note in *Section 3.1.2 on page 12* Modified *Table 6 on page 23* (mass erase operation) Modified *Section 7.3 on page 26*
24-Feb-2011	4	Modified *Section 3: Flash module organization on page 9* Modified title of *Section 4.3 on page 14* Modified *Section 4.3.1: Program memory Fast Word Write on page 14*

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